



YOUSHANG SEMICONDUCTOR

设计研发新型功率器件

各类小信号开关

中低压及高压大电流等场效应管

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Features

- $BV_{CEO} > -40V$
- $I_C = -1A$ High Continuous Current
- Low Saturation Voltage $V_{CE(SAT)} < -500mV @ -1A$
- Complementary NPN Type: NK-FZT491A

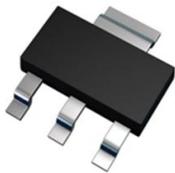
Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.112 grams (Approximate)

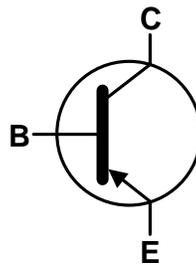
Applications

- Power MOSFET & IGBT Gate Driving
- Low Loss Power Switching

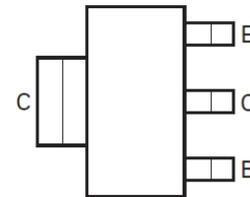
SOT223 (Type DN)



Top View



Device Symbol



Top View
Pin-Out

Absolute Maximum Ratings

 (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-40	V
Collector-Emitter Voltage	V_{CEO}	-40	V
Emitter-Base Voltage	V_{EBO}	-7	V
Continuous Collector Current	I_C	-1	A
Base Current	I_B	-200	mA
Peak Pulse Current	I_{CM}	-2	A

Thermal Characteristics

 (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	P_D	(Note 6)	2	W
		(Note 7)	3	W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	(Note 6)	62.5	$^\circ\text{C/W}$
		(Note 7)	41.7	$^\circ\text{C/W}$
Thermal Resistance, Junction to Leads (Note 8)	$R_{\theta JL}$	19.4	$^\circ\text{C/W}$	
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$	

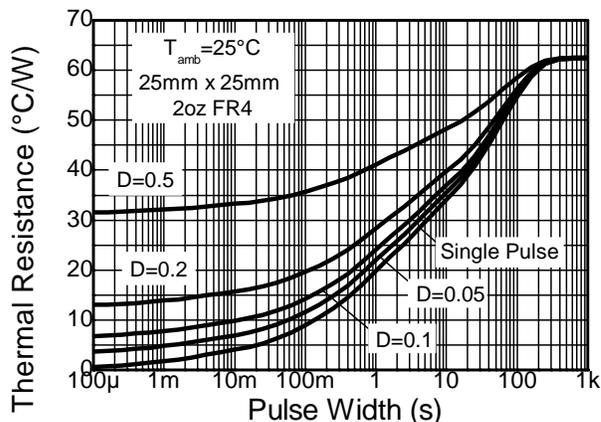
ESD Ratings

 (Note 9)

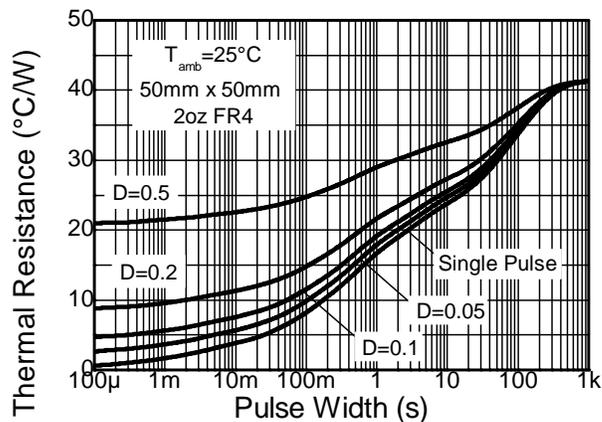
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	8,000	V	3B
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
6. For a device mounted with the collector lead on 25mm x 25mm 2oz copper that is on a single sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
 7. Same as Note 6, except mounted on 50mm x 50mm 2oz copper.
 8. Thermal resistance from junction to solder-point (at the end of the collector lead).
 9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

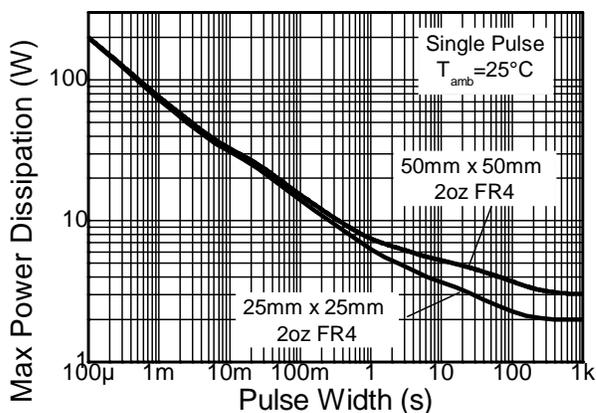
Thermal Characteristics and Derating Information



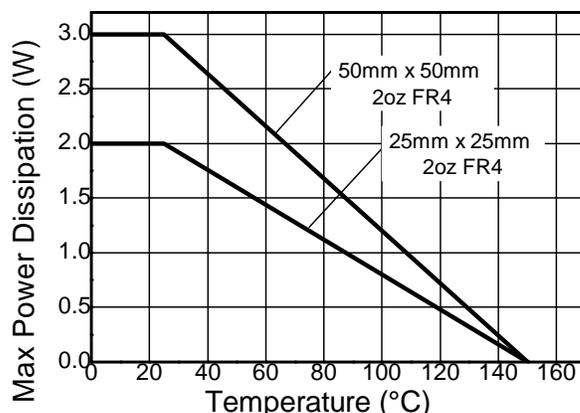
Transient Thermal Impedance



Transient Thermal Impedance



Pulse Power Dissipation



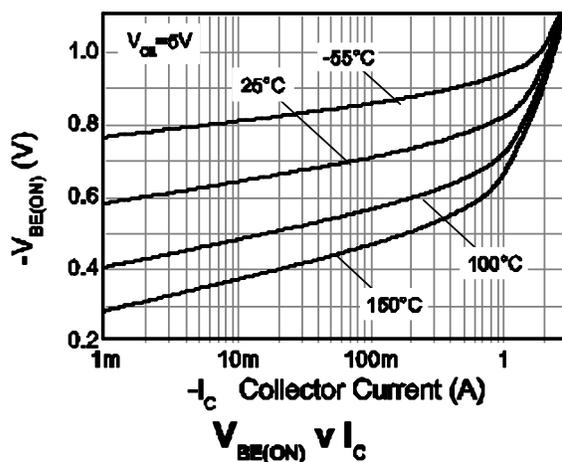
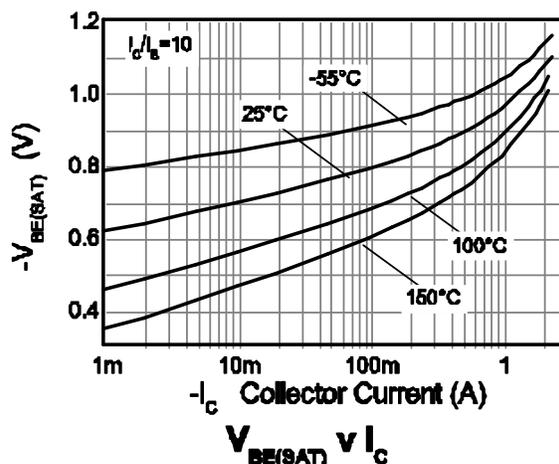
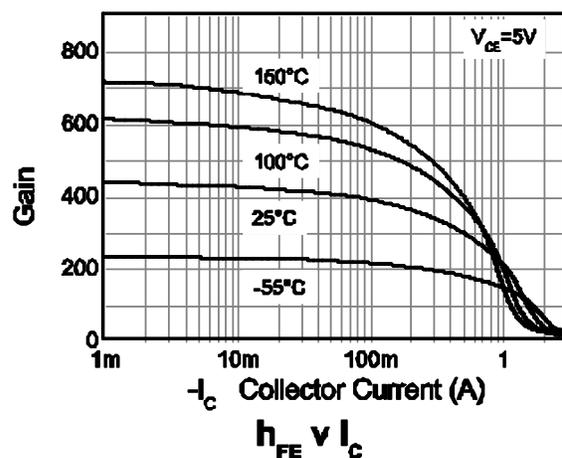
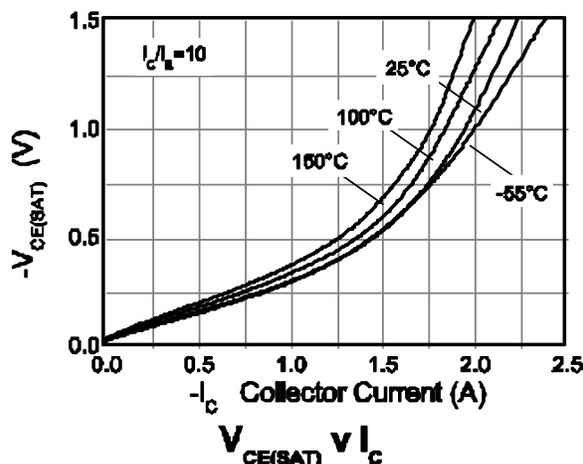
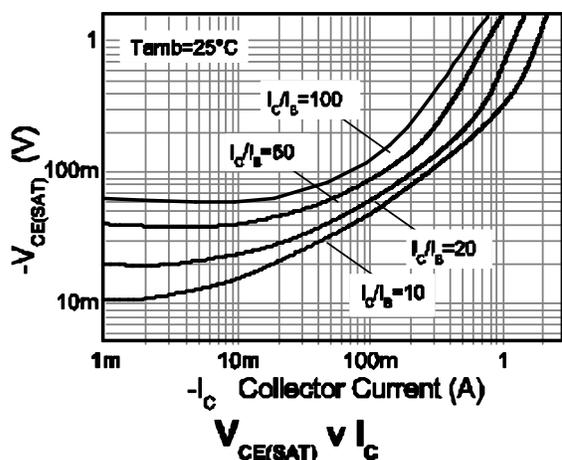
Derating Curve

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-40	–	–	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	-40	–	–	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	–	–	V	I _E = -100μA
Collector Cut-Off Current	I _{CBO}	–	–	-100	nA	V _{CB} = -30V
Collector Cut-Off Current	I _{CES}	–	–	-100	nA	V _{CE(S)} = -30V
Emitter Cut-Off Current	I _{EBO}	–	–	-100	nA	V _{EB} = -4V
Collector-Emitter Saturation Voltage (Note 10)	V _{CE(SAT)}	–	–	-0.2 -0.35 -0.5	V	I _C = -100mA, I _B = -1mA I _C = -500mA, I _B = -20mA I _C = -1A, I _B = -100mA
Base-Emitter Saturation Voltage (Note 10)	V _{BE(SAT)}	–	–	-1.1	V	I _C = -1A, I _B = -50mA
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(ON)}	–	–	-1.0	V	I _C = -1A, V _{CE} = -5V
DC Current Transfer Static Ratio (Note 10)	h _{FE}	300 300 250 160 30	– – – – –	– 800 – – –	–	I _C = -1mA, V _{CE} = -5V I _C = -100mA, V _{CE} = -5V I _C = -500mA, V _{CE} = -5V I _C = -1A, V _{CE} = -5V I _C = -2A, V _{CE} = -5V
Transitional Frequency (Note 10)	f _T	150	–	–	MHz	V _{CE} = -10V, I _C = -50mA f = 100MHz
Output Capacitance (Note 10)	C _{obo}	–	–	10	pF	V _{CB} = -10V, f = 1MHz

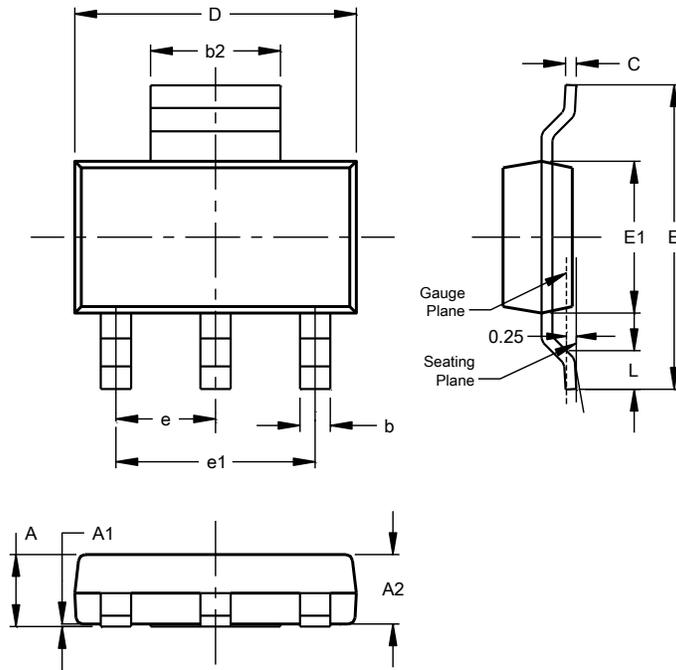
Note: 10. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



Package Outline Dimensions

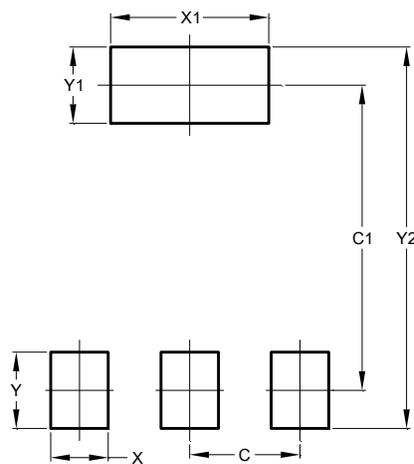
SOT223 (Type DN)



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Dim	Min	Max	Typ
A	--	1.70	--
A1	0.01	0.15	--
A2	1.50	1.68	1.60
b	0.60	0.80	0.70
b2	2.90	3.10	--
c	0.20	0.32	--
D	6.30	6.70	--
E	6.70	7.30	--
E1	3.30	3.70	--
e	--	--	2.30
e1	--	--	4.60
L	0.85	--	--
All Dimensions in mm			

Suggested Pad Layout

SOT223 (Type DN)



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00